



GR551x Reliability Test Report

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Preface

Purpose

This document introduces GR551x reliability qualification results, providing users with product reliability performance and reference standard, including device level and package level reliability test results.

Audience

This document is intended for:

- GR551x user
- GR551x developer
- Bluetooth product engineer
- Bluetooth system designer

Release Notes

This document is the second release of *GR551x Reliability Test Report*, corresponding to GR551x SoC series.

Revision History

Version	Date	Description
1.0	2020-02-19	Initial release
1.1	2023-04-20	<ul style="list-style-type: none">• Updated a test point (1000h) to the HTOL test and the test passed.• Updated a test point (1000 h) to the HTST test and the test passed.

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1 Overview

The Goodix GR551x family is a single-mode, low-power Bluetooth 5.1 System-on-Chip (SoC). This report aims to provide a detailed description of the methods used to verify that the product under test meets Goodix stringent quality and reliability requirements. Each test is described and the results are presented. The evaluations done for this qualification are included in the following sections.

2 Reliability Test Items and Results

2.1 Electrostatic Discharge: Human Body Model (HBM)

Table 2-1 Human body model test requirements

Reference Standard	ESDA/JEDEC JS-001-2017
Test Parameter	I-V curve / Function test
Model	Human Body Model
Test Conditions	RP=1.5 kΩ, C=100 pF
Sample Size	3 ea. per mode
Criteria	Pass / Fail = 0 / 1

Table 2-2 Test results

HBM Sensitivity	Class	All Pin Combination
+/-2000 V	2	Power to power (+/-) IO to power (+/-) IO to IO (+/-)

2.2 Electrostatic Discharge: Charged Device Model (CDM)

Table 2-3 Charged device model test requirements

Reference Standard	ESDA/JEDEC JS-002-2014
Test Parameter	I-V curve / Function test
Model	Charged Device Model
Test Conditions	RP=0 Ω, C=0 pF
Sample Size	3 ea. per mode
Criteria	Pass / Fail = 0 / 1

Table 2-4 Test results

CDM Sensitivity	Class	Pin Combination
+/-500 V	C2a	All pin (+/-) to common ground

2.3 Latch Up (LU)

Table 2-5 Latch up test requirements

Reference Standard	JESD-78D
Test Parameter	I-V curve / Function test

Model	Current / Voltage trigger
Test Conditions	+/-200 mA trigger / over voltage
Sample Size	3 ea. per mode
Criteria	Pass / Fail = 0 / 1

Table 2-6 Test results

Test Result	Class
I trigger	
Over voltage test	I

2.4 High Temperature Operating Life Test (HTOL)

Table 2-7 High temperature operating life test requirements

Reference Standard	JESD22-A108D
Test Parameter	Function test
Model	Arrhenius model for temperature acceleration factor and voltage $AF = \exp \left[\beta * \left(V_{stress} - V_{op} \right) \right] * \exp \left[\frac{Ea}{K} \left(\frac{1}{T_{op}} - \frac{1}{T_{stress}} \right) \right]$
Test Conditions	125°C, 1000 hrs., VCCmax
Sample Size	77
Criteria	Pass / Fail = 0 / 1

Table 2-8 Test results

Time Point	168 hrs.	500 hrs.	1000 hrs.
Result	Pass	Pass	Pass

2.5 Pre-Conditioning (Pre-Con)

Table 2-9 Pre-conditioning test requirements

Reference Standard	JESD22-A113F
Test Parameter	Function test / Appearance inspection
Model	None
Test Conditions	3x reflow, 30°C/60% RH, 192 hrs.
Sample Size	308
Criteria	Pass / Fail = 0 / 1

Table 2-10 Test results

Time Point	Pre-con over
Result	Pass

2.6 Temperature Cycling Test (TCT)

Table 2-11 Temperature cycling test requirements

Reference Standard	JESD22-A104E
Test Parameter	Function test / Appearance inspection
Model	None
Test Conditions	-65°C to 150°C, 500 cycles
Sample Size	77
Criteria	Pass / Fail=0 / 1

Table 2-12 Test results

Time Point	500 cycles
Result	Pass

2.7 Highly Accelerated Temperature and Humidity Stress Test (HAST)

Table 2-13 Highly accelerated temperature and humidity stress test requirements

Reference Standard	JESD22-A110D
Test Parameter	Function test / Appearance inspection
Model	None
Test Conditions	Vccmax, 130°C, 85% RH, 96 hrs
Sample Size	77
Criteria	Pass / Fail=0 / 1

Table 2-14 Test results

Time Point	96 hrs.
Result	Pass

2.8 High Temperature Storage Test (HTST)

Table 2-15 High temperature storage test requirements

Reference Standard	JESD22-A103C
Test Parameter	Function test

Model	None
Test Conditions	150°C, 1000 hrs.
Sample Size	77
Criteria	Pass / Fail=0 / 1

Table 2-16 Test results

Time Point	1000 hrs.
Result	Pass

2.9 Unbiased Highly Accelerated Temperature and Humidity Stress Test (UHAST)

Table 2-17 Unbiased highly accelerated temperature and humidity stress test requirements

Reference Standard	JESD22-A118
Test Parameter	Function test / Appearance inspection
Model	None
Test Conditions	130°C, 85% RH, 96 hrs
Sample Size	77
Criteria	Pass / Fail=0 / 1

Table 2-18 Test results

Time Point	96 hrs
Result	Pass